



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

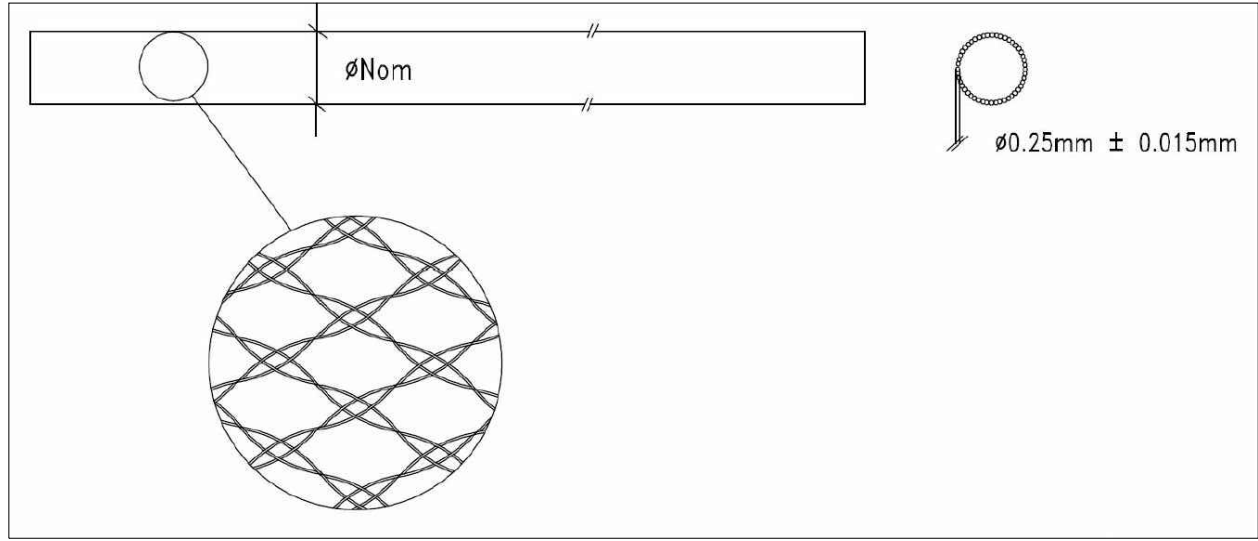
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USED ON -



CABLE BUNDLE MANAGEMENT SYSTEM							
REF	PART No.	NOM ID	MAX OD	MIN REC CABLE OD	MAX REC CABLE OD	M NOM (g/m)	REEL
CBMS-10-P	EG1595-000	10	32	5	25	2.900	200m
CBMS-20-P	EG1596-000	20	42	10	38	3.100	200m
CBMS-40-P	EG1598-000	40	58	20	52	3.700	180M

CBMS - 10 - X

PRODUCT DESCRIPTION \_\_\_\_\_  
 SIZE (mm) \_\_\_\_\_  
 MATERIAL \_\_\_\_\_  
 P = PBT V0 NATO GREEN \_\_\_\_\_

CUSTOMER DRAWING

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DWG NO CBMS-XX-X		THIS DRAWING IS A CONTROLLED DOCUMENT		USED ON -	
DIMENSIONS M/M 		TOLERANCES UNLESS OTHERWISE SPECIFIED 0 PLC ±0.1 1 PLC ±0.1 2 PLC ±0.05 3 PLC ±0.005 4 PLC ±0.0005		DWN N. NAGAR 08 JUN 2016 MATERIAL - HEAT TREAT - CHK J. SEABOURNE 09 JUN 2016 APVD A. POOLE 09 JUN 2016	
A INITIAL RELEASE 08 JUN 2016 NN AP		ANGLE ± 0° 30'		<b>STE</b> TE Connectivity	
LTR REVISION RECORD DATE DWN APVD		SURFACE TEXTURE 1.6		NAME CABLE BUNDLING MANAGEMENT SYSTEM SCALE DNS SIZE A2 DRAWING NO CBMSXX-X SHEET 1 OF 1 REV A	